

Call for Papers



Sponsored by

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ICPT 2018 aims at continue the tradition of providing a platform for sharing and promoting new technological innovation for positioning. This conference will bring together people to discuss, exchange and expose ideas, methods and results in conventional, contemporary and future topics of positioning and ultraprecision positioning technologies. ICPT 2018 will be held on Tuesday through Friday, November 27 to 30, 2018 at the Ambassador Hotel, in Kaohsiung, Taiwan.

Located at the south-western coast of Taiwan, Kaohsiung is the most beautiful ocean city and is the second largest city in Taiwan with population of 2.8 million. The city is with a modernized transportation network including an international airport, a high-speed rail (HSR) system, a metro rapid transit system, and a natural harbor. Kaohsiung is also an important transit to southern and eastern Taiwan, and it takes only about 1.5 hour from Taipei to Kaohsiung by High Speed Railway. Known as the home of heavy industry, Kaohsiung is building new science parks including bio and information technology (IT). Kaohsiung attractions include Sizihwan Bay, NSYSU, 85 Sky tower, Love River, Fo Guang Shan Buddha Museum, Cijin Island, Dragon Tiger Tower, etc. The average temperature in November of Kaohsiung is comfortable, around 21-25 °C.



Topics

The conference focuses on the followings, but are not limited to:

- Actuators
- Assembly
- Applications
- Control methods
- Case studies
- Data processing
- Materials and Mechanism
- Modeling
- Mechatronics
- Nanotechnology
- Positioning design
- Positioning system
- Positioning components
- Sensors and measurement instruments
- Simulation

Language

English is the official language of the conference for all presentations and correspondence.

Abstract and Paper Submission

Authors should submit a high quality copy of an abstract including the following: a) the title of a paper, b) author name(s) and affiliation(s), c) the corresponding author's name and title, d) his/her postal address, phone number, fax number and e-mail address, e) a 300-word abstract including brief backgrounds, objectives, methods and results, f) several keywords, g) a contribution type (long or short paper) and h) a presentation type (oral or poster). They should be typed on a single sheet of plain A4 (210×296 mm) paper with 25-mm margins, single spaced, using a 12 point font. The inclusion of figures in the abstract is not recommended. Papers, which have been published in another form elsewhere in either English or any other languages, are also welcome if they are reconstructed from new aspects.

The program committee will evaluate your proposals. Due to limited speaker slots, some papers may be accepted as poster presentations. All abstracts accepted will require one or more of the authors to attend the conference for the presentation.

The camera-ready manuscript should be 2 to 6 pages in length. They will be published in the conference proceedings. Abstract and camera-ready manuscript must be submitted to the online paper submission system. If there has any question, please contact: icpt2018_nsysu@mem.nsysu.edu.tw

Important Dates

- The deadline of the abstracts is **August 25, 2018** and the submission of abstracts via e-mail or fax is not accepted.
- Acceptance letters and author's kits for a camera-ready manuscript will be sent by **September 10, 2018**.
- Final camera-ready manuscripts for accepted papers must be sent by **October 15, 2018**.

Schedule

- November 27 : Registration and Reception
28 : Conference meeting and Banquet
29 : Conference meeting and Closing Remark
30 : Technical tours

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Conference Website

<http://www2.nsysu.edu.tw/ICPT2018/> (Open soon)

Conference Venue

Ambassador Hotel, Kaohsiung, Taiwan
<https://www.ambassador-hotels.com/tc/kaohsiung>

Participation Fee

The participation fee is about 350 USD or 10,200 NTD, and **300 USD for early bird** or 8,700 NTD. **This includes registrations, proceedings, lunch and banquet. The participation fee for student participants is 150 USD** or 4,400 NTD without banquet. **Fee for banquet is about 70 USD** or 2,000 NTD. **Fee for optional factory tour is 50 USD** or 1,500 NTD.

For more information, please contact:

ICPT2018 Secretariat

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